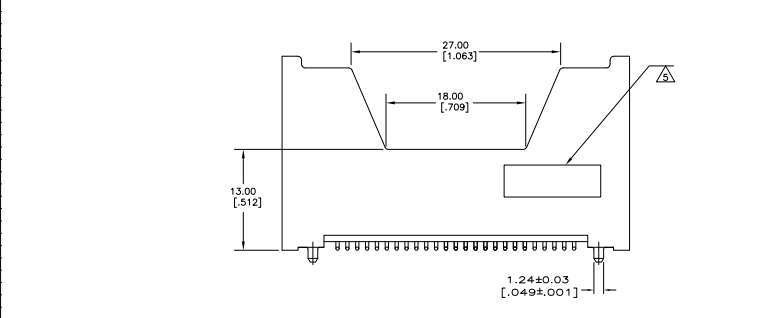
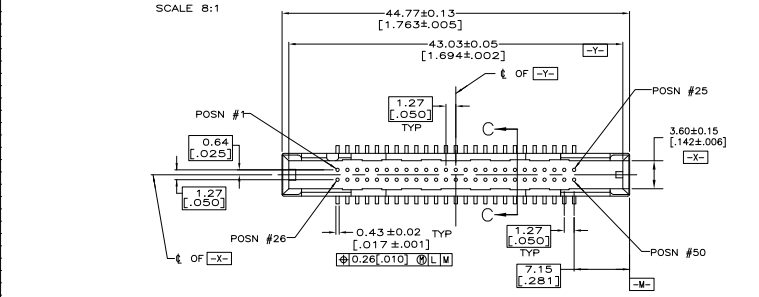
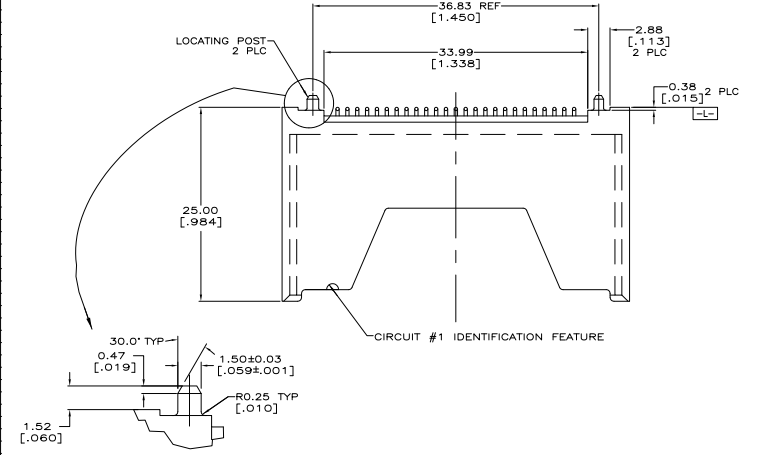
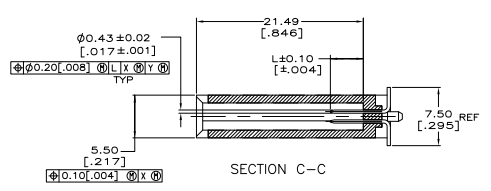
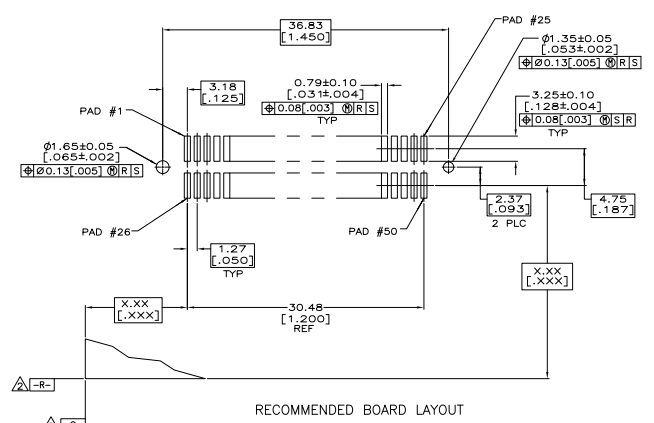


REV	DATE	DESCRIPTION	BY	APP'D
GP 00				
		REVISED PER EDD-10-012216	21MAR10	HMR DG



- ⚠ 0.00038 [0.00015] MINIMUM GOLD IN CONTACT AREA, 0.00381 [0.00150] MIN TIN-LEAD ON SOLDER TAILS, ALL OVER 0.00127 [0.00050] MINIMUM NICKEL.
- ⚠ DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- ⚠ PARTS TO BE PACKAGED IN TRAYS.
- ⚠ EITHER 0.00038 [0.00015] MINIMUM GOLD OR 0.00005 [0.00002] MIN GOLD OVER 0.000254 [0.00010] PALLADIUM NICKEL IN CONTACT AREA, 0.00381 [0.00150] MIN 100% TIN ON SOLDER TAILS, ALL OVER 0.00127 [0.00050] MINIMUM NICKEL.
- ⚠ COPMANY LOGO IN APPROXIMATE AREA SHOWN.



SUPERSEDE 146540-1 WITH 146540-2	ACTIVE	PACKAGING	1,13,38,50	ALL OTHER PINS	25,26	146540-2
	FINISH	PART STATUS	5.00 [0.197]	4.24 [1.67]	3.51 [1.38]	146540-1
			* PIN LENGTH & CAVITY LOCATION			ASSEMBLY PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DATE: 03/27/10		TYS Electronics Corporation	
DESIGNER: []	ENGINEER: []	DATE: []	BY: []	Harrisburg, PA 17105-3608	
WORKS: []	PROJECT: []	PROJECT: []	PROJECT: []	PIN HEADER ASSEMBLY, VERTICAL, 50 POSN, SURFACE MOUNT.	
DATE: []	DATE: []	DATE: []	DATE: []	SIZE: []	DRAWING NO: []
DATE: []	DATE: []	DATE: []	DATE: []	SIZE: []	DRAWING NO: []
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